

Inventor: Rickie C. Lake  
Title: An Epoxy, Epoxy System, and Method of Forming a Conductive  
Adhesive Connection  
Assignee: Micron Technology, Inc.  
Attorney File No. MI40-327



**INFORMATION DISCLOSURE STATEMENT**

**PURSUANT TO 37 C.F.R. §§ 1.56, 1.97 AND 1.98**

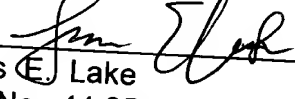
In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, your attention is directed to the United States patents and other references listed on the attached Form PTO-1449. No admission is made regarding whether all the submitted references are prior art.

The listed references were cited by, or submitted to, the Office in the parent, co-pending application of the above-identified application. The above-identified application is a continuation application of co-pending application Serial No. 09/392,073, filed September 8, 1999. Such prior disclosure is sufficient for the above-identified application as far as copies of the references are concerned. 37 C.F.R. § 1.98(d) and MPEP § 609(2).

Citation of these references is respectfully requested.

Respectfully submitted,

Dated: 26 Apr 2001

By:   
James E. Lake  
Reg. No. 44,854

**EL 465782735**

Form PTO-1449

U.S. DEPARTMENT OF COMMERCE  
PATENT AND TRADEMARK OFFICEATTY. DOCKET NO.  
MI40-327SERIAL NO.  
Priority 09392,073LIST OF ART CITED BY APPLICANT  
(Use several sheets if necessary)APPLICANT  
Rickie C. LakeFILING DATE  
Priority September 8, 1999GROUP  
Priority 1751

## U.S. PATENT DOCUMENTS

*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
	AA	5,649,296	7/15/97	MacLellan et al.	455	38.2	6/19/95
	AB	5,621,412	4/15/97	Sharpe et al.	342	51	6/7/95
	AC	4,926,182	5/15/90	Ohta et al.	342	44	5/29/87
	AD	4,075,632	2/21/78	Baldwin et al.	343	6.8	5/24/76
	AE	4,587,038	6/6/86	Tamura			
	AF	4,469,714	9/4/84	Wada et al.			
	AG	4,780,371	10/25/88	Joseph et al.			
	AH	4,324,713	4/13/82	Kita et al.			
	AI	4,210,704	7/1/80	Chandross et al.			
	AJ	5,021,473	6/4/91	Macholdt et al.			
	AK	4,661,562	4/28/87	Goel			
	AL	5,431,795	7/11/95	Morelant et al			
	AM	5,068,062	11/26/91	Inata et al			

## FOREIGN PATENT DOCUMENTS

		Document Number	Date	Country	Class	Subclass	Translation	
							Yes	No
	AN							
	AO							
	AP							
	AQ							
	AR							

## OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)

	AS		
	AT		

EXAMINER

DATE CONSIDERED

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

31002 U.S. PTO  
09/04/01

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